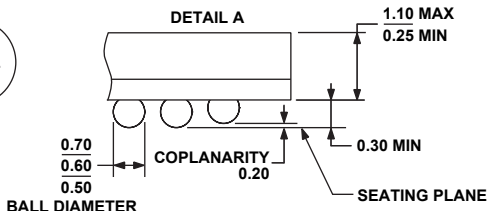
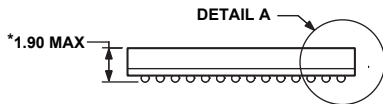
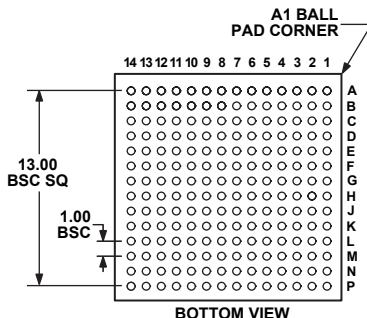
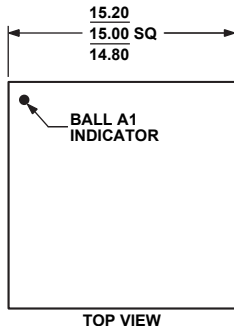


# 196-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]

(BC-196-4)

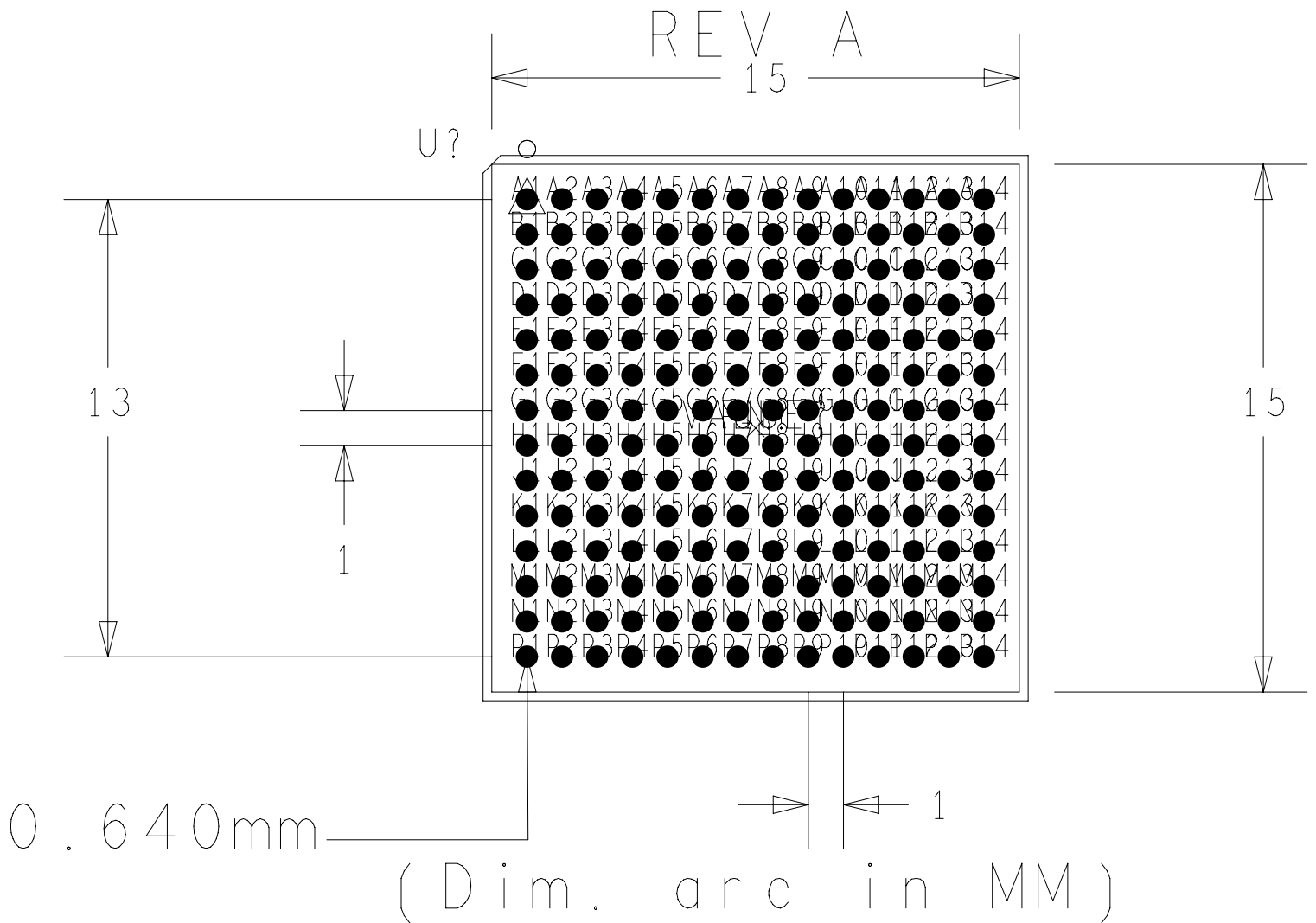
Dimensions shown in millimeters



\*COMPLIANT TO JEDEC STANDARDS MO-192-AAE-1  
WITH THE EXCEPTION TO PACKAGE HEIGHT.

# Analog Devices

BC-196-4



LAST MODIFIED 09/11/07